



# N-Channel 40-V (D-S) 175 °C MOSFET

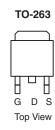
PRODUCT SUMMARY				
V <sub>(BR)DSS</sub> (V)	$r_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)		
40	$0.0023$ at $V_{GS} = 10 \text{ V}$	1108		
	0.0038 at V <sub>GS</sub> = 4.5 V	110 <sup>a</sup>		

### **FEATURES**

- TrenchFET® Power MOSFET
- New Package with Low Thermal Resistance

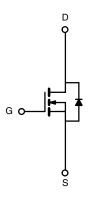


RoHS\*



Ordering Information: SUM110N04-02L

SUM110N04-02L-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25$ °C, unless other Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current (T <sub>.1</sub> = 175 °C)	T <sub>C</sub> = 25 °C		110 <sup>a</sup>	۸	
Continuous Diam Current (1) = 175 C)	T <sub>C</sub> = 125 °C	I <sub>D</sub>	110 <sup>a</sup>		
Pulsed Drain Current		I <sub>DM</sub>	440	A A	
Avalanche Current		I <sub>AR</sub>	75		
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	280	mJ	
b	T <sub>C</sub> = 25 °C	В	437.5 <sup>c</sup>	W	
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.75		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount <sup>d</sup>	$R_{thJA}$	40	°C/W	
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.4	- C/VV	

#### Notes:

- a. Package limited.
- b. Duty cycle  $\leq$  1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).
- \* Pb containing terminations are not RoHS compliant, exemptions may apply.

## SUM110N04-02L

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$	40			V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3		
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			100	nA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V			1	μΑ	
	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50		
		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.00185	0.0023	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0031	0.0038		
	r <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.0037		
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C			0.0046		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	30			S	
Dynamic <sup>b</sup>	<del>!</del>				<b>,</b>		
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz		7300		pF	
Output Capacitance	C <sub>oss</sub>			1380			
Reverse Transfer Capacitance	C <sub>rss</sub>			930			
Total Gate Charge <sup>c</sup>	Qg			165	250	nC	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$		25			
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			55			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			30	45	ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, R_L = 0.27 \Omega$ $I_D \cong 110 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		80	120		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			155	230		
Fall Time <sup>c</sup>	t <sub>f</sub>			120	180		
Source-Drain Diode Ratings and Cha	aracteristics	r <sub>C</sub> = 25 °C <sup>b</sup>					
Continuous Current	Is		110				
Pulsed Current	I <sub>SM</sub>				240	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V		1.1	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			60	90	ns	
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = 85 A, di/dt = 100 A/μs		2.6	4	Α	
Reverse Recovery Charge	Q <sub>rr</sub>			0.08	0.15	μС	

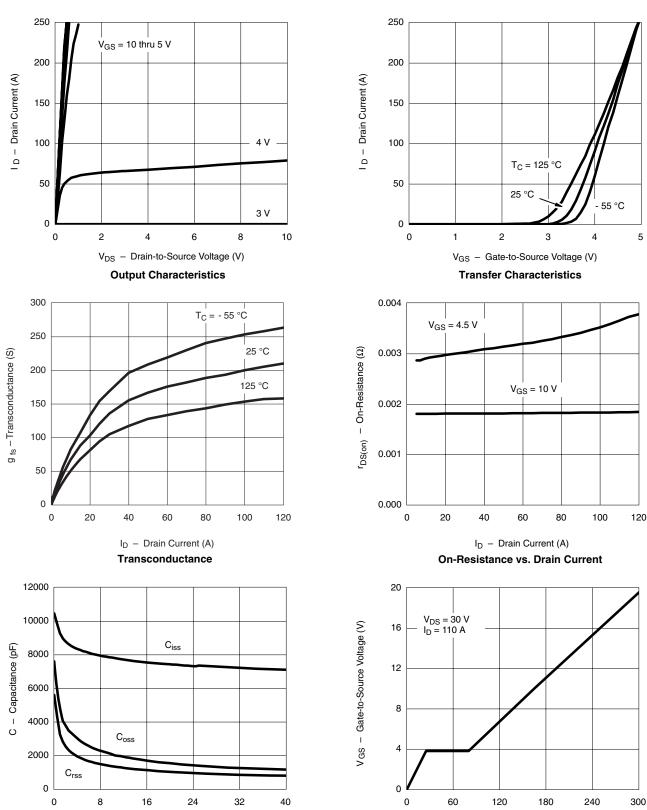
### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



V<sub>DS</sub> - Drain-to-Source Voltage (V)

Capacitance

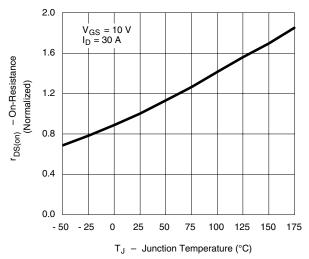
Q<sub>g</sub> - Total Gate Charge (nC)

**Gate Charge** 

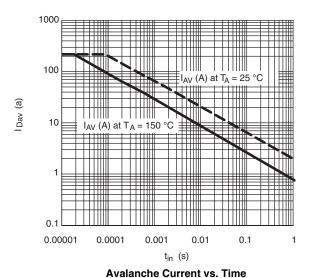
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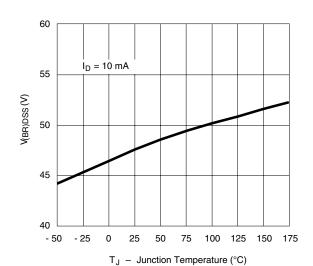
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



### On-Resistance vs. Junction Temperature



### Source-Drain Diode Forward Voltage

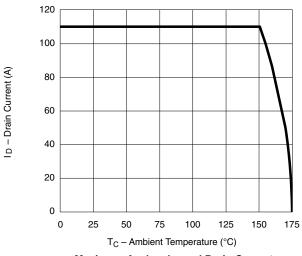


Drain Source Breakdown vs. Junction Temperature

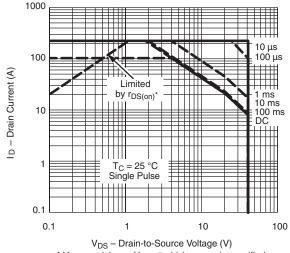




### **THERMAL RATINGS**

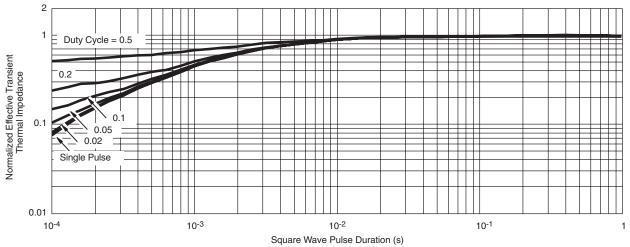


Maximum Avalanche and Drain Current vs. Case Temperature



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which r<sub>DS(on)</sub> is specified

Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

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